S2GF~S2MF

ROHS

Surface Mount General Purpose Silicon Rectifiers

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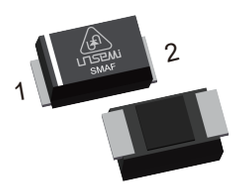
Features

- For surface mounted applications
- Low profile package
- Glass passivated chip junction
- Easy to pick and place
- Lead free in comply with EU RoHS 2011/65/EU directives

Mechanical Data

- Case: SMAF
- Quantity Per Reel : 3,000pcs
- Approx. Weight : 27mg / 0.00095oz
- Terminals: Solderable per MIL-STD-750, Method 2026

SMAF



1：Cathode
2：Anode

Maximum Ratings and Electrical Characteristics

Ratings at 25℃ ambient temperature unless otherwise specified.
Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

Parameter		Symbol	S2GF	S2JF	S2KF	S2MF	Units
Maximum Repetitive Peak Reverse Voltage		V_{RRM}	400	600	800	1000	V
Maximum RMS Voltage		V_{RMS}	280	420	560	700	V
Maximum DC Blocking Voltage		V_{DC}	400	600	800	1000	V
Maximum Average Forward Rectified Current at Tc =125℃		$I_{F(AV)}$	2.0				A
Peak Forward Surge Current,8.3ms Single Half Sine-wave Superimposed on Rated Load		I_{FSM}	50				A
Max Instantaneous Forward Voltage at 2A		V_F	1.1				V
Maximum DC Reverse Current at Rated DC Reverse Voltage	Ta=25℃	I_R	5.0				μA
	Ta=125℃	I_R	100				
Typical Junction Capacitance (1)		Cj	22				pF
Typical Thermal Resistance (2)		$R_{\theta JA}$	65				℃/W
		$R_{\theta JC}$	20				
Operating and Storage Temperature Range		T_J,Tstg	-55 ~ +150				℃

Note: (1) Measured at 1MHz and applied reverse voltage of 4VDC.
(2) P.C.B. mounted with 2.0" X 2.0" (5 X 5cm) copper pad areas.

Electrical Characteristics Curves

Fig.1 Forward Current Derating Curve

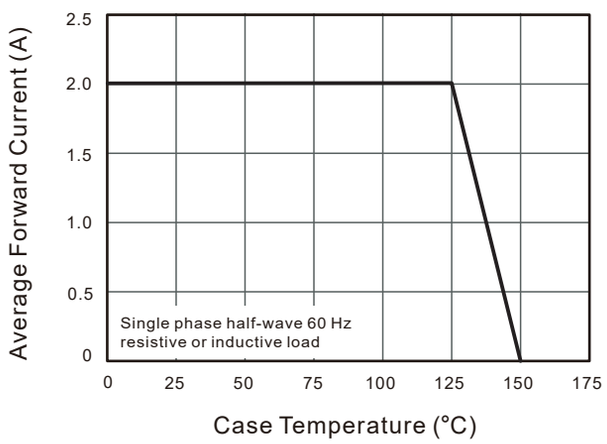


Fig. 2 Typical Instaneous Reverse Characteristics

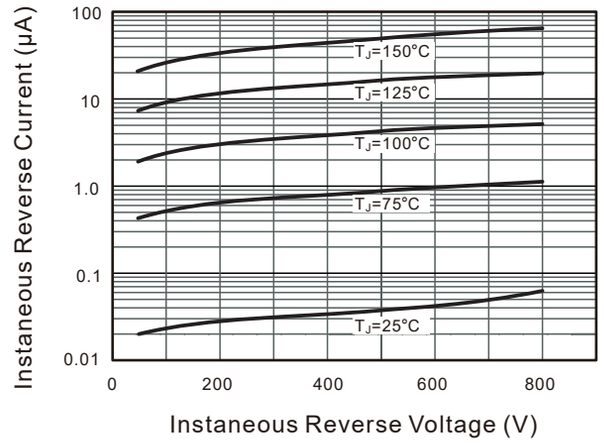


Fig.3 Typical Forward Characteristic

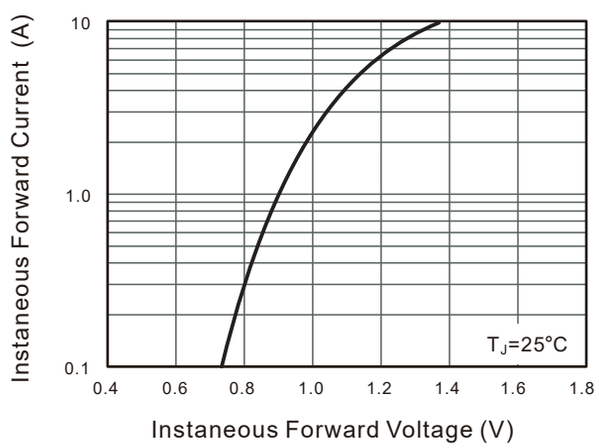


Fig. 4 Typical Junction Capacitance

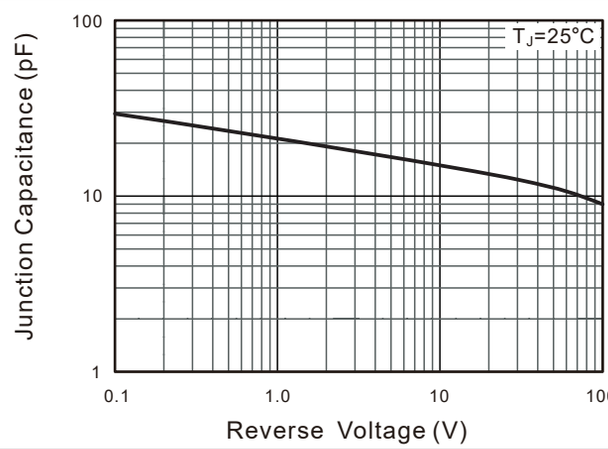
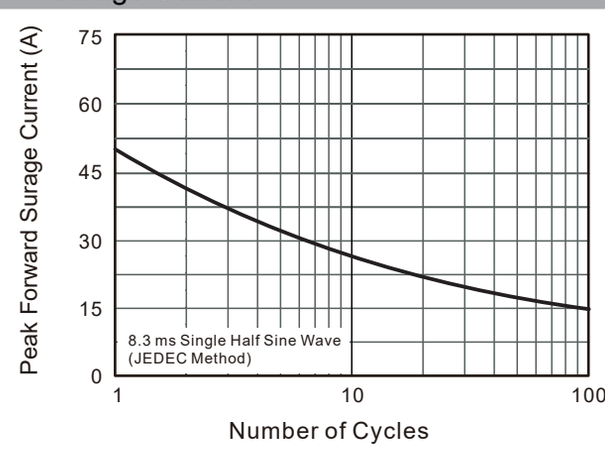
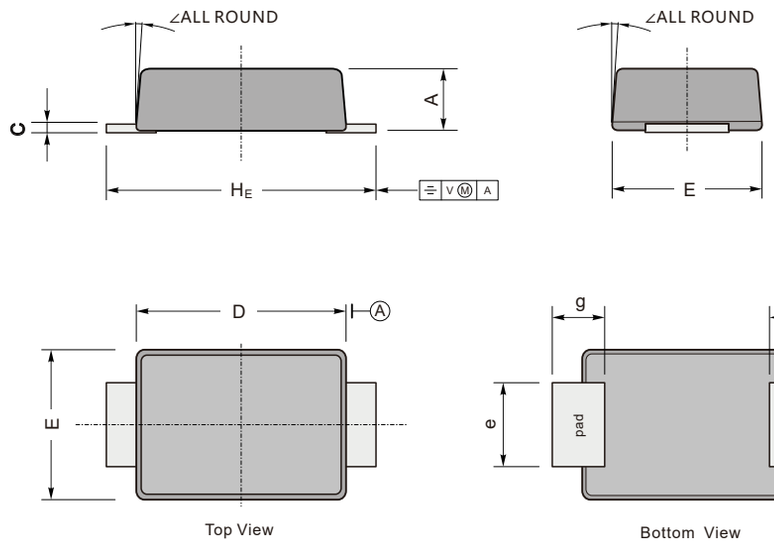


Fig.5 Maximum Non-Repetitive Peak Forward Surage Current



Package Outline & Dimensions



UNIT		A	C	D	E	e	g	HE	∠
mm	max	1.2	0.20	3.7	2.7	1.6	1.2	4.9	7°
	min	0.9	0.12	3.3	2.4	1.3	0.8	4.4	
mil	max	47	7.9	146	106	63	47	193	
	min	35	4.7	130	94	51	31	173	

Marking

Type Number	S2GF	S2JF	S2KF	S2MF
Making	S2G	S2J	S2K	S2M

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ROHS

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